NANOSCALE ELASTIC-PROPERTY MAPPING WITH CONTACT-RESONANCE-FREQUENCY AFM

Donna Hurley^{1*}, Tony Kos², and Paul Rice¹

¹Materials Reliability Division, ²Electromagnetics Division, NIST Boulder, Colorado USA

*hurley@boulder.nist.gov





Introduction and Motivation

- Mechanical properties are critical in many applications
 - predictive modeling of complex systems
 - performance and reliability
- Increasing need for information on the nanoscale
- Existing methods not optimal (too big, destructive, qualitative, ...)
- Imaging visualization increasingly important
 - multiple materials integrated at micro-, nanoscale
 - failure often due to local property variations

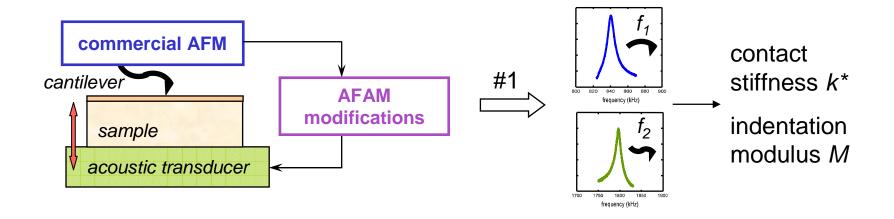
Objective:

Develop AFM methods for quantitative elastic-property imaging Approach based on atomic force acoustic microscopy (AFAM)



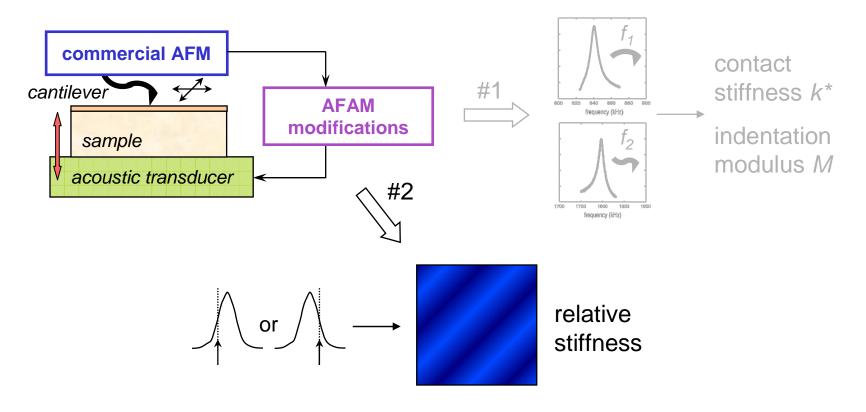
Nanoscale Elastic Measurements with AFAM

1. sweep frequency at fixed tip position \rightarrow quantitative point measurement



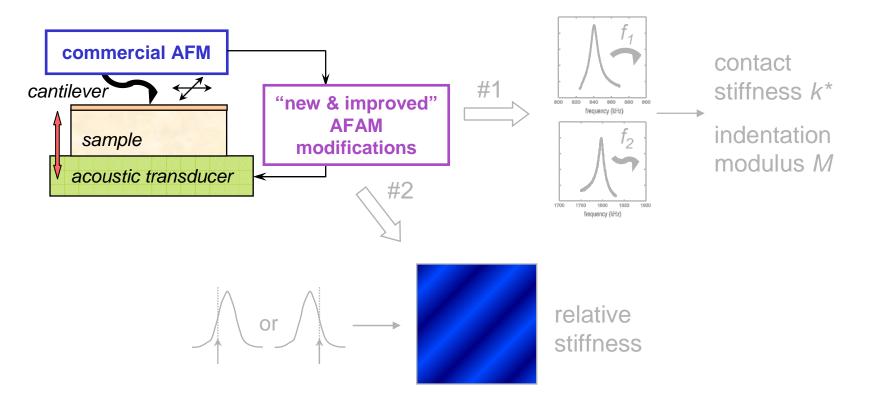
Nanoscale Elastic Measurements with AFAM

- 1. sweep frequency at fixed tip position → quantitative point measurement
- OR 2. scan tip position at fixed frequency → qualitative image



Nanoscale Elastic Measurements with AFAM

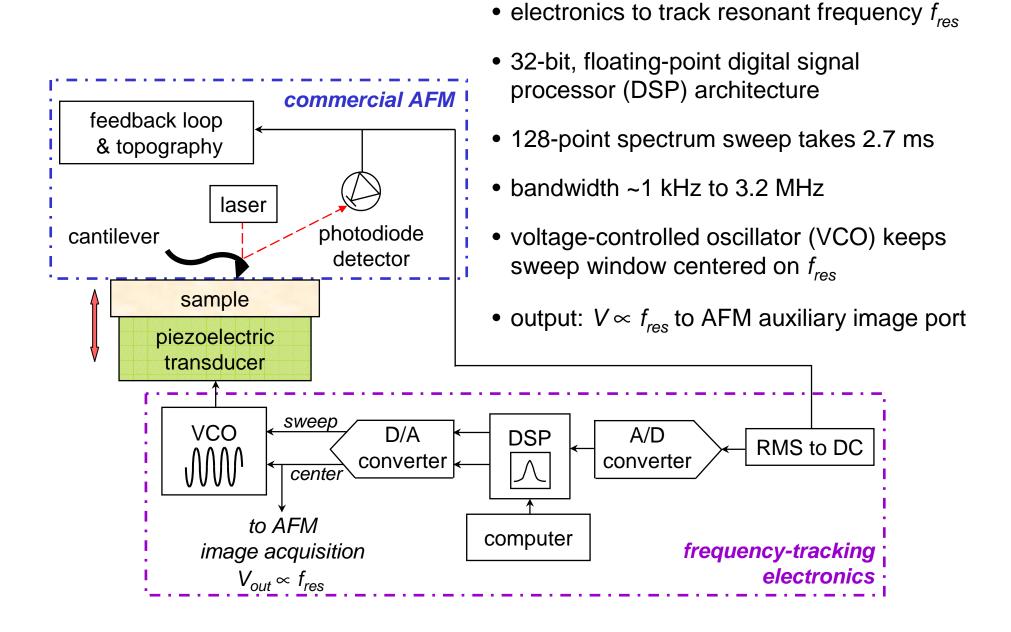
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- OR 2. scan tip position at fixed frequency → qualitative image



NEXT: Quantitative imaging of elastic properties

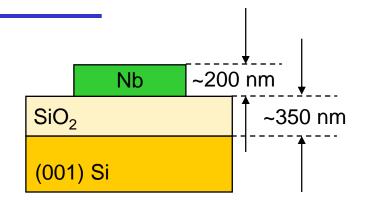
CHALLENGE: Do it fast!

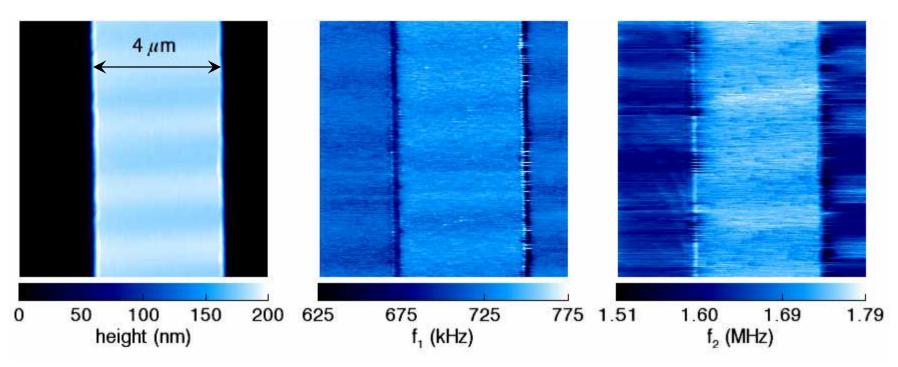
Contact-Resonance Frequency Imaging



Examples of Frequency Images

- 4 μm niobium "wire" on silica blanket film
- Image lowest 2 flexural (bending) modes
- ~22 minutes for each 256 x 256 image

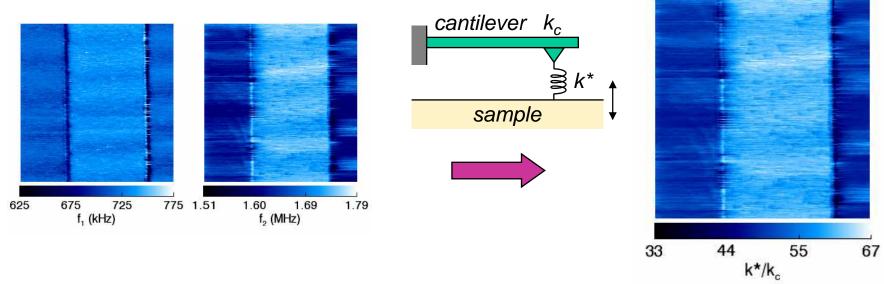




cantilever used (vendor specs): $k_c = 47$ N/m, L = 225 μ m, W = 34 μ m, t = 7.1 μ m

Using Resonant-Frequency Images **To Obtain Elastic-Property Information**

• Contact stiffness: calculate k^*/k_c from f_1 and f_2 with beam-dynamics model



Elastic modulus: requires data from reference material

$$E_{sample}^{*} = E_{ref}^{*} \left(\frac{K_{sample}^{*} / K_{c}}{K_{ref}^{*} / K_{c}} \right)^{n} \qquad \frac{1}{E^{*}} = \frac{1}{M_{tip}} + \frac{1}{M_{sample}} \qquad M = \frac{E}{1 - v^{2}}$$

n=1 flat punch n=3/2 Hertzian $M_{tip} = 165$ GPa for Si <100>

$$\frac{1}{E^*} = \frac{1}{M_{tip}} + \frac{1}{M_{sample}}$$

$$M_{\rm tip} = 165 \; {\rm GPa} \; {\rm for} \; {\rm Si} \; {<} 100 >$$

$$M = \frac{E}{1 - v^2}$$

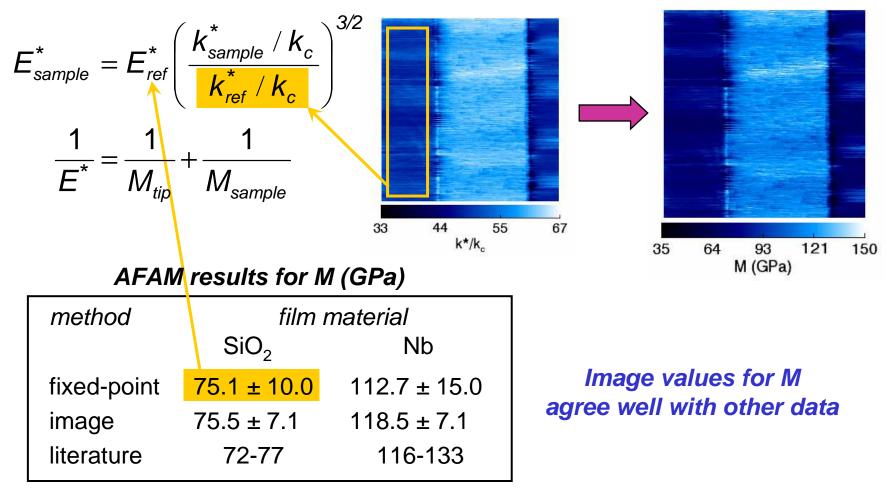
(isotropic)

E = Young's modulus

v = Poisson's ratio

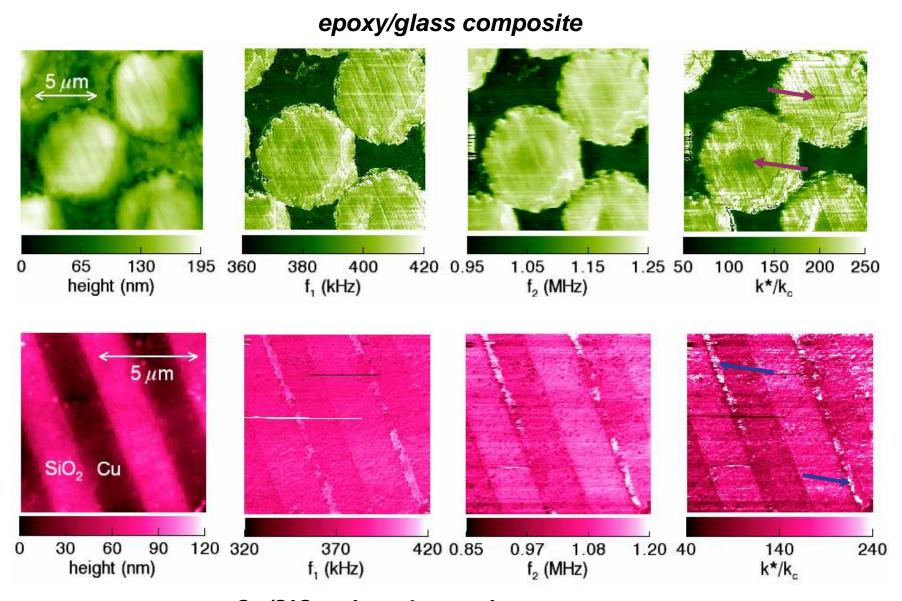
Calculating Modulus Maps from Contact-Stiffness Images

- Assume Hertzian contact mechanics
- Use "self-calibrating" method based on fixed-point measurements



reference: fused silica, M = 74.9 GPa

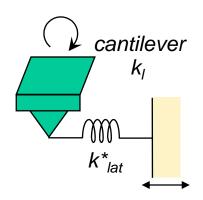
Additional Flexural-Mode Images

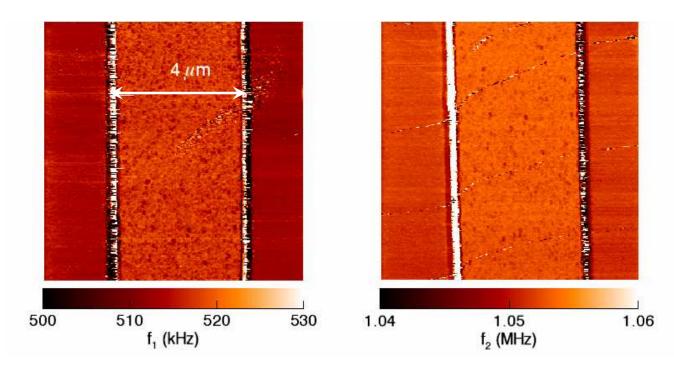


Cu/SiO₂ microelectronic test structure

Torsional Mode Images

- Detect torsional modes with left-to-right photodiode signal
- Obtain lateral (horizontal) contact stiffness k^*_{lat}
- Yields information about shear modulus $G = \frac{E}{2(1+v)}$
- Next: develop methods to calculate k_{lat}^* , G from f_1 and f_2





cantilever used (vendor specs): $k_c = 1$ N/m, L = 448 μ m, W = 51 μ m, t = 3.5 μ m

Summary and Conclusions

- AFAM uses contact-resonance modes of the AFM cantilever to nondestructively measure elastic properties.
- We have developed frequency-tracking electronics to obtain *nanoscale elastic-property maps* with AFAM.
- Flexural- and torsional-mode frequency images were shown to demonstrate the basic approach.
- Contact-stiffness images using flexural-mode images yield values of M in agreement with other results.
- Several issues (contact mechanics, calibration, etc.)
 must be further addressed for truly quantitative imaging.

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